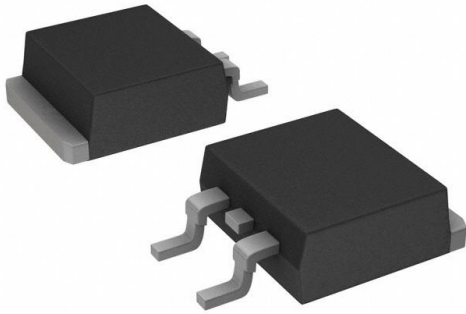


# IRFR9120TRLPBF-BE3 Datasheet

[www.digi-electronics.com](http://www.digi-electronics.com)



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	IRFR9120TRLPBF-BE3-DG
Manufacturer	<a href="#">Vishay Siliconix</a>
Manufacturer Product Number	IRFR9120TRLPBF-BE3
Description	MOSFET P-CH 100V 5.6A DPAK
Detailed Description	P-Channel 100 V 5.6A (Tc) 2.5W (Ta), 42W (Tc) Surface Mount TO-252AA



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

DiGi is a global authorized distributor of electronic components.

## Purchase and inquiry

Manufacturer Product Number:

IRFR9120TRLPBF-BE3

Series:

-

FET Type:

P-Channel

Drain to Source Voltage (Vdss):

100 V

Drive Voltage (Max Rds On, Min Rds On):

10V

Vgs(th) (Max) @ Id:

4V @ 250 $\mu$ A

Vgs (Max):

$\pm$ 20V

FET Feature:

-

Operating Temperature:

-55°C ~ 150°C (Tj)

Supplier Device Package:

TO-252AA

Base Product Number:

IRFR9120

Manufacturer:

Vishay Siliconix

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

5.6A (Tc)

Rds On (Max) @ Id, Vgs:

600mOhm @ 3.4A, 10V

Gate Charge (Qg) (Max) @ Vgs:

18 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

390 pF @ 25 V

Power Dissipation (Max):

2.5W (Ta), 42W (Tc)

Mounting Type:

Surface Mount

Package / Case:

TO-252-3, DPAK (2 Leads + Tab), SC-63

## Environmental & Export classification

Moisture Sensitivity Level (MSL):

1 (Unlimited)

HTSUS:

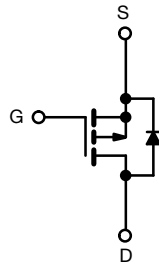
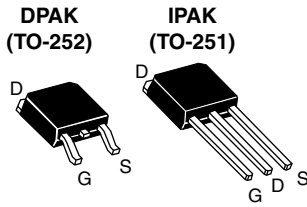
8541.29.0095

ECCN:

EAR99



## Power MOSFET



P-Channel MOSFET

### FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Surface-mount (IRFR9120, SiHFR9120)
- Straight lead (IRFU9120, SiHFU9120)
- Available in tape and reel
- P-channel
- Fast switching
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available

### PRODUCT SUMMARY

$V_{DS}$ (V)	-100	
$R_{DS(on)}$ ( $\Omega$ )	$V_{GS} = -10$ V	0.60
$Q_g$ (Max.) (nC)	18	
$Q_{gs}$ (nC)	3.0	
$Q_{gd}$ (nC)	9.0	
Configuration	Single	

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface-mount applications.

### ORDERING INFORMATION

Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)
Lead (Pb)-free and halogen-free	SiHFR9120-GE3	SiHFR9120TR-GE3 <sup>a</sup>	SiHFR9120TRL-GE3 <sup>a</sup>	-	SiHFU9120-GE3
	IRFR9120PbF-BE3	IRFR9120TRPbF-BE3	IRFR9120TRLPbF-BE3	-	-
Lead (Pb)-free	IRFR9120PbF	IRFR9120TRPbF <sup>a</sup>	IRFR9120TRLPbF <sup>a</sup>	IRFR9120TRRPbF	IRFU9120PbF

#### Note

a. See device orientation

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	$V_{DS}$	-100	V
Gate-source voltage	$V_{GS}$	$\pm 20$	
Continuous drain current	$V_{GS}$ at -10 V	$T_C = 25^\circ\text{C}$	-5.6
		$T_C = 100^\circ\text{C}$	-5.6
Pulsed drain current <sup>a</sup>	$I_{DM}$	-22	A
Linear derating factor		0.33	
Linear derating factor (PCB mount) <sup>e</sup>		0.020	
Single pulse avalanche energy <sup>b</sup>	$E_{AS}$	210	mJ
Repetitive avalanche current <sup>a</sup>	$I_{AR}$	-5.6	A
Repetitive avalanche energy <sup>a</sup>	$E_{AR}$	4.2	mJ
Maximum power dissipation	$P_D$	$T_C = 25^\circ\text{C}$	42
Maximum power dissipation (PCB mount) <sup>e</sup>		$T_A = 25^\circ\text{C}$	2.5
Peak diode recovery dV/dt <sup>c</sup>	dV/dt	-5.5	V/ns
Operating junction and storage temperature range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s	260	

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- $V_{DD} = -25$  V, starting  $T_J = 25^\circ\text{C}$ ,  $L = 10$  mH,  $R_g = 25 \Omega$ ,  $I_{AS} = -5.6$  A (see fig. 12)
- $I_{SD} \leq -6.8$  A,  $dI/dt \leq 110$  A/ $\mu\text{s}$ ,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 150^\circ\text{C}$
- 1.6 mm from case
- When mounted on 1" square PCB (FR-4 or G-10 material)



## IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	$R_{thJA}$	-	-	110	°C/W	
Maximum junction-to-ambient (PCB mount) <sup>a</sup>	$R_{thJA}$	-	-	50		
Maximum junction-to-case (drain)	$R_{thJC}$	-	-	3.0		

**Note**

a. When mounted on 1" square PCB (FR-4 or G-10 material)

SPECIFICATIONS ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
<b>Static</b>							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$		- 100	-	-	V
$V_{DS}$ temperature coefficient	$\Delta V_{DS}/T_J$	Reference to $25\text{ }^\circ\text{C}$ , $I_D = -1\text{ mA}$		-	- 0.098	-	V/°C
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$		- 2.0	-	- 4.0	V
Gate-source leakage	$I_{GSS}$	$V_{GS} = \pm 20\text{ V}$		-	-	$\pm 100$	nA
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -100\text{ V}, V_{GS} = 0\text{ V}$		-	-	- 100	$\mu\text{A}$
		$V_{DS} = -80\text{ V}, V_{GS} = 0\text{ V}, T_J = 125\text{ }^\circ\text{C}$		-	-	- 500	
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = -10\text{ V}$	$I_D = -3.4\text{ A}^b$	-	-	0.60	$\Omega$
Forward transconductance	$g_{fs}$	$V_{DS} = -50\text{ V}, I_D = -3.4\text{ A}$		1.5	-	-	S
<b>Dynamic</b>							
Input capacitance	$C_{iss}$	$V_{GS} = 0\text{ V},$ $V_{DS} = -25\text{ V},$ $f = 1.0\text{ MHz}$ , see fig. 5		-	390	-	$\mu\text{F}$
Output capacitance	$C_{oss}$			-	170	-	
Reverse transfer capacitance	$C_{rss}$			-	45	-	
Total gate charge	$Q_g$	$V_{GS} = -10\text{ V}$	$I_D = -6.8\text{ A}, V_{DS} = -80\text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	18	nC
Gate-source charge	$Q_{gs}$			-	-	3.0	
Gate-drain charge	$Q_{gd}$			-	-	9.0	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -50\text{ V}, I_D = -6.8\text{ A},$ $R_g = 18\text{ }\Omega, R_D = 7.1\text{ }\Omega$ , see fig. 10 <sup>b</sup>		-	9.6	-	ns
Rise time	$t_r$			-	29	-	
Turn-off delay time	$t_{d(off)}$			-	21	-	
Fall time	$t_f$			-	25	-	
Internal drain inductance	$L_D$	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal source inductance	$L_S$			-	7.5	-	
<b>Drain-Source Body Diode Characteristics</b>							
Continuous source-drain diode current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 5.6	A
Pulsed diode forward current <sup>a</sup>	$I_{SM}$			-	-	- 22	
Body diode voltage	$V_{SD}$	$T_J = 25\text{ }^\circ\text{C}, I_S = -5.6\text{ A}, V_{GS} = 0\text{ V}^b$		-	-	- 6.3	V
Body diode reverse recovery time	$t_{rr}$	$T_J = 25\text{ }^\circ\text{C}, I_F = -6.8\text{ A}, dl/dt = 100\text{ A}/\mu\text{s}^b$		-	100	200	ns
Body diode reverse recovery charge	$Q_{rr}$			-	0.33	0.66	$\mu\text{C}$
Forward turn-on time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )					

**Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)  
 b. Pulse width  $\leq 300\text{ }\mu\text{s}$ ; duty cycle  $\leq 2\text{ }\%$



# IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

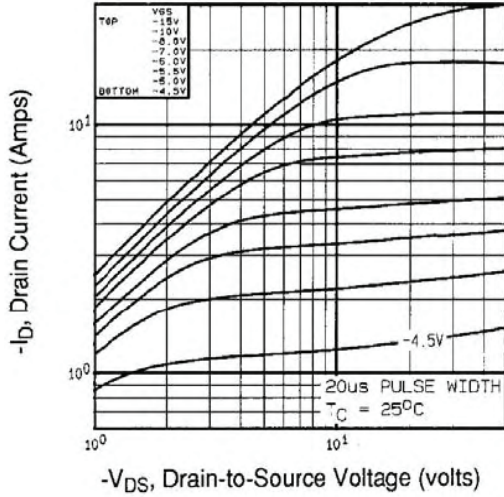


Fig. 1 - Typical Output Characteristics,  $T_C = 25^\circ\text{C}$

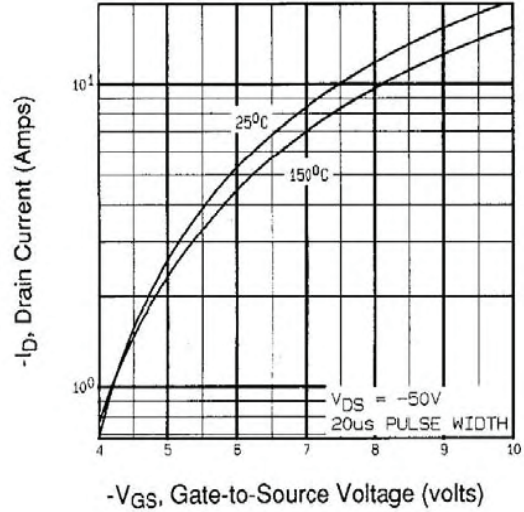


Fig. 2 - Typical Transfer Characteristics

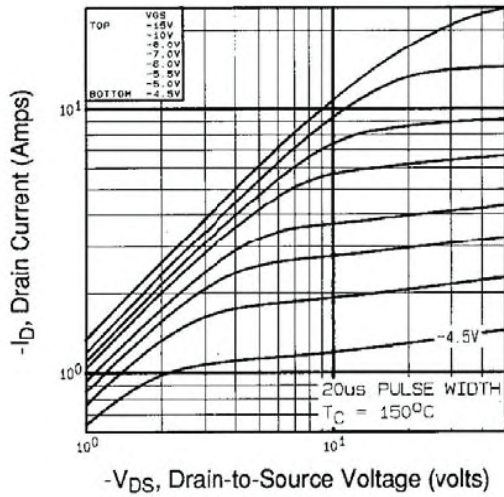


Fig. 1 - Typical Output Characteristics,  $T_C = 150^\circ\text{C}$

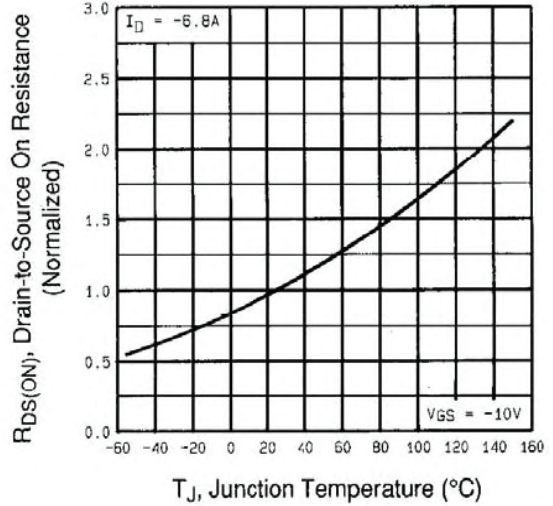


Fig. 3 - Normalized On-Resistance vs. Temperature



# IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

Vishay Siliconix

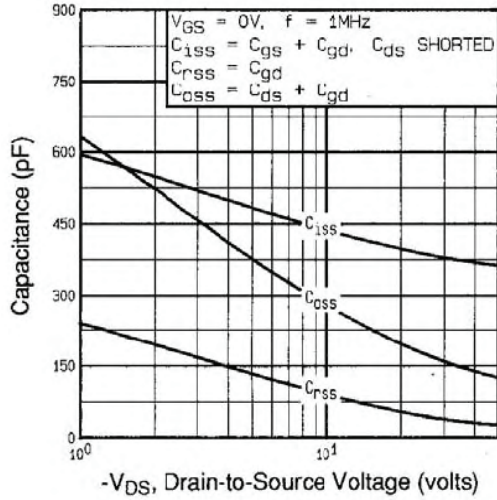


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

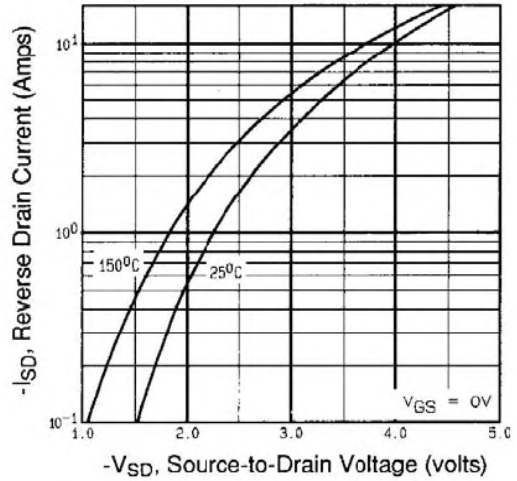


Fig. 6 - Typical Source-Drain Diode Forward Voltage

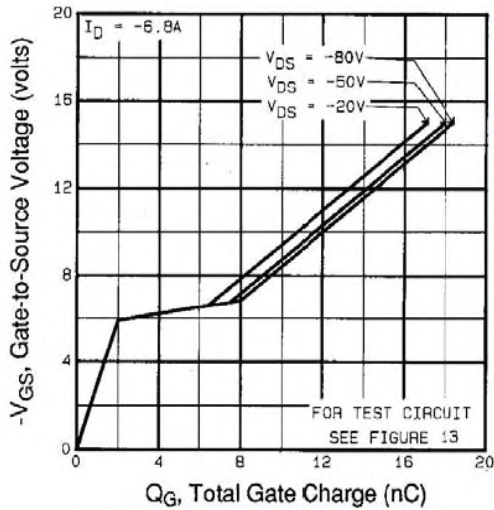


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

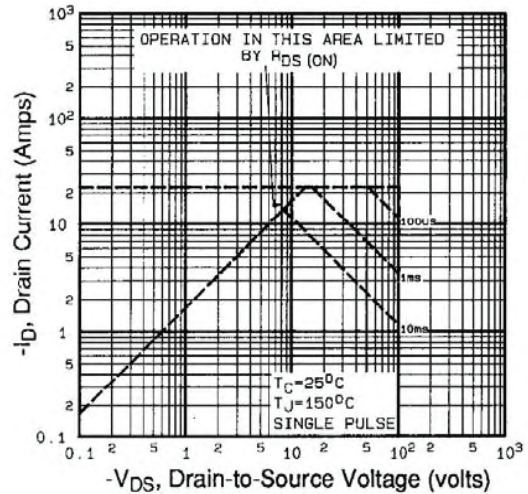


Fig. 7 - Maximum Safe Operating Area



# IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

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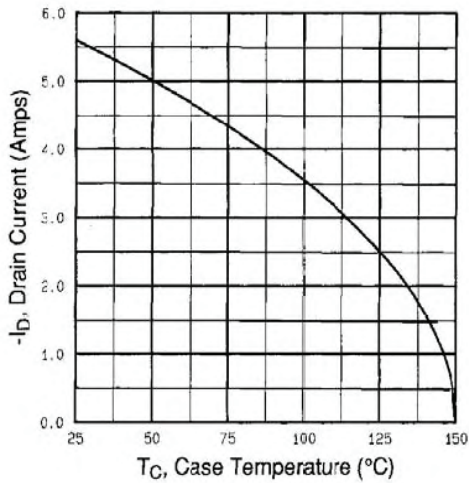


Fig. 8 - Maximum Drain Current vs. Case Temperature

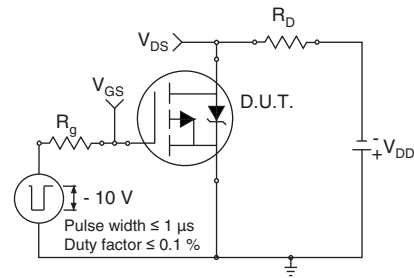


Fig. 10a - Switching Time Test Circuit

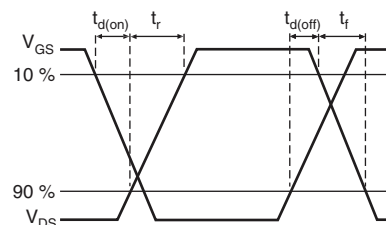


Fig. 10b - Switching Time Waveforms

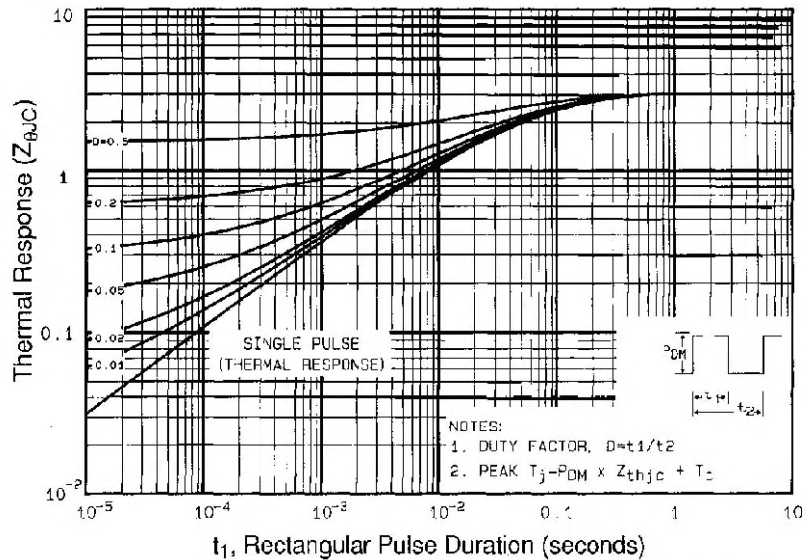


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



# IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

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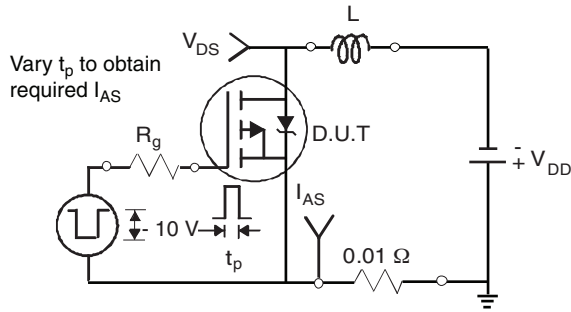


Fig. 12a - Unclamped Inductive Test Circuit

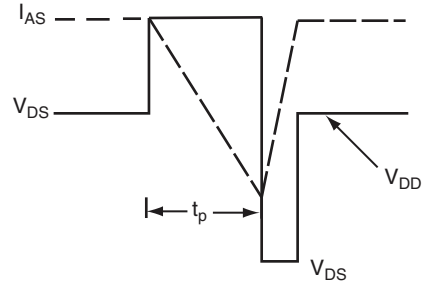


Fig. 12b - Unclamped Inductive Waveforms

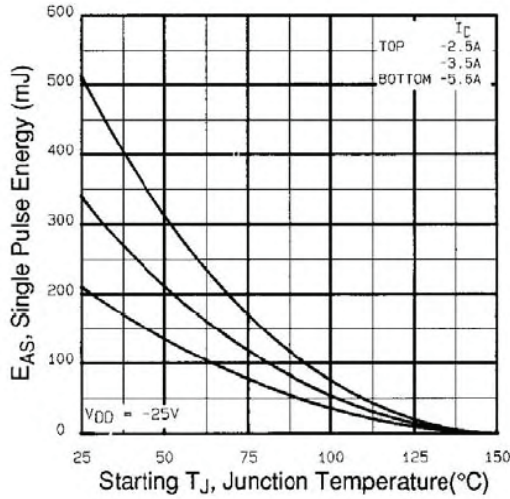


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

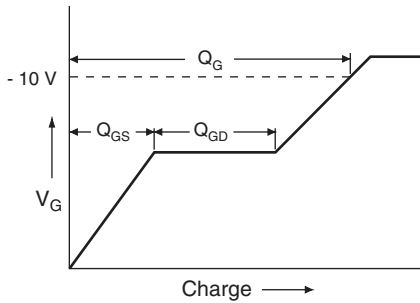


Fig. 13a - Basic Gate Charge Waveform

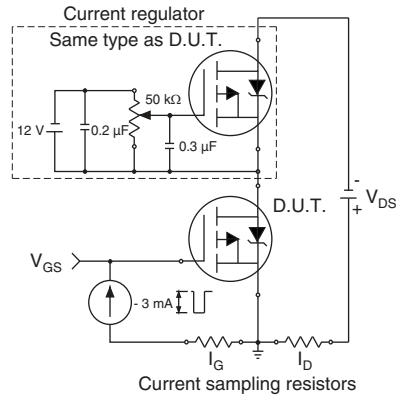
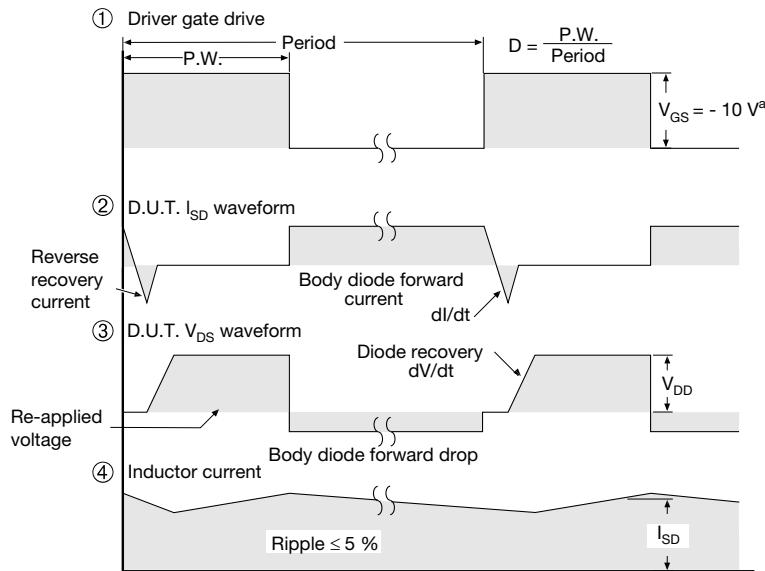
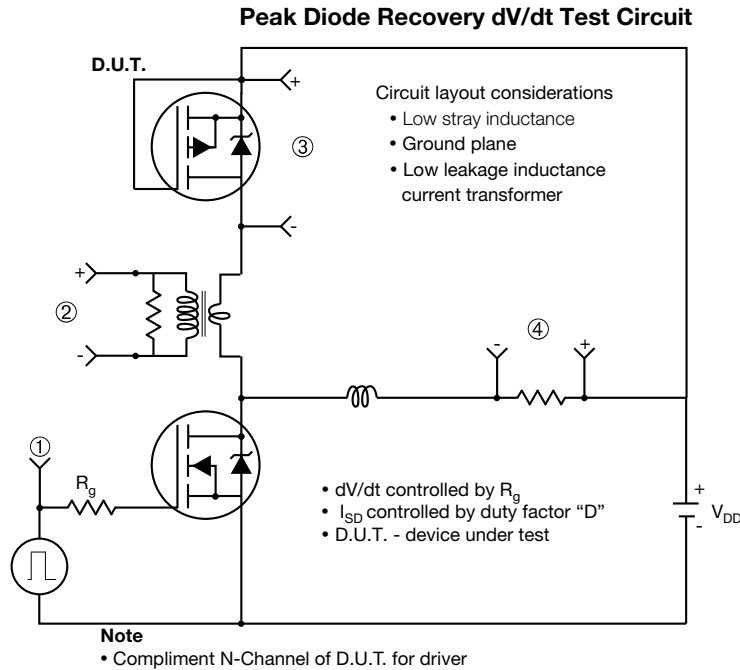


Fig. 13b - Gate Charge Test Circuit





# IRFR9120, IRFU9120, SiHFR9120, SiHFU9120



**Note**  
a.  $V_{GS} = -5\text{ V}$  for logic level and  $-3\text{ V}$  drive devices

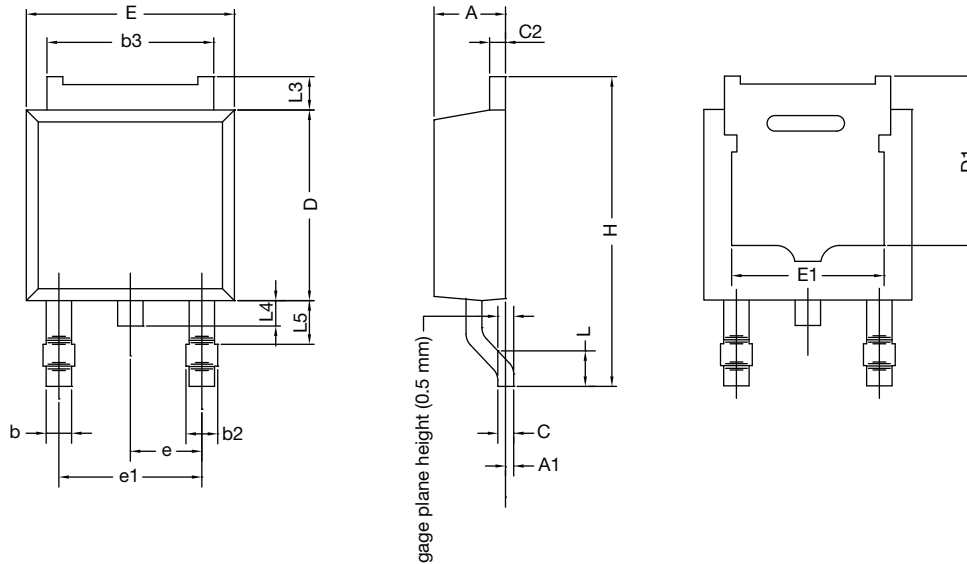
**Fig. 10 - For P-Channel**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?91280](http://www.vishay.com/ppg?91280).



## TO-252AA Case Outline

## VERSION 1: FACILITY CODE = Y



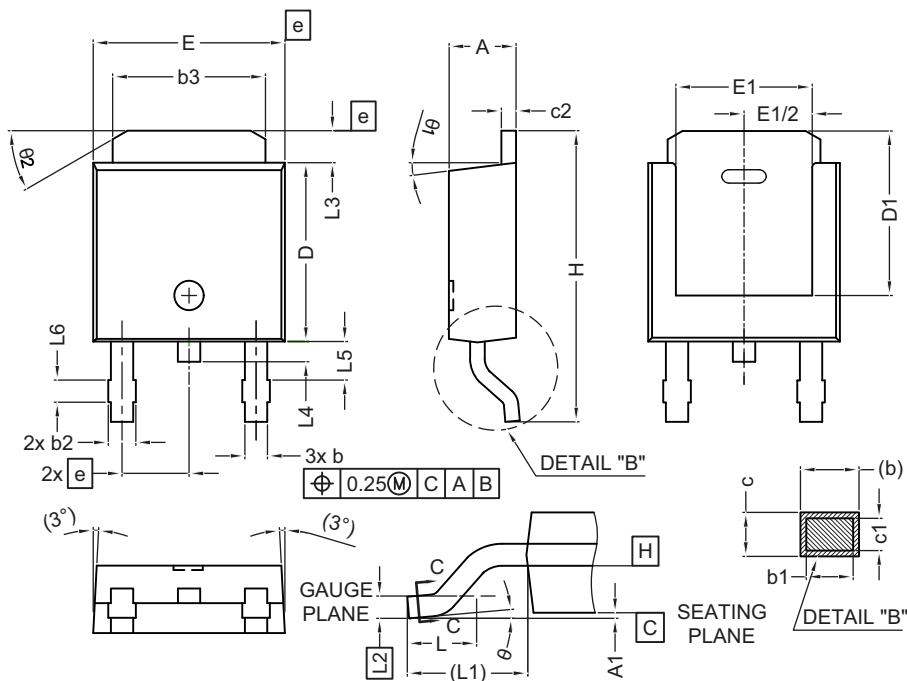
DIM.	MILLIMETERS	
	MIN.	MAX.
A	2.18	2.38
A1	-	0.127
b	0.64	0.88
b2	0.76	1.14
b3	4.95	5.46
C	0.46	0.61
C2	0.46	0.89
D	5.97	6.22
D1	4.10	-
E	6.35	6.73
E1	4.32	-
H	9.40	10.41
e	2.28 BSC	
e1	4.56 BSC	
L	1.40	1.78
L3	0.89	1.27
L4	-	1.02
L5	1.01	1.52

**Note**

- Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



MILLIMETERS		
DIM.	MIN.	MAX.
A	2.18	2.39
A1	-	0.13
b	0.65	0.89
b1	0.64	0.79
b2	0.76	1.13
b3	4.95	5.46
c	0.46	0.61
c1	0.41	0.56
c2	0.46	0.60
D	5.97	6.22
D1	5.21	-
E	6.35	6.73
E1	4.32	-
e	2.29 BSC	
H	9.94	10.34

MILLIMETERS		
DIM.	MIN.	MAX.
L	1.50	1.78
L1	2.74 ref.	
L2	0.51 BSC	
L3	0.89	1.27
L4	-	1.02
L5	1.14	1.49
L6	0.65	0.85
$\theta$	0°	10°
$\theta 1$	0°	15°
$\theta 2$	25°	35°

Notes

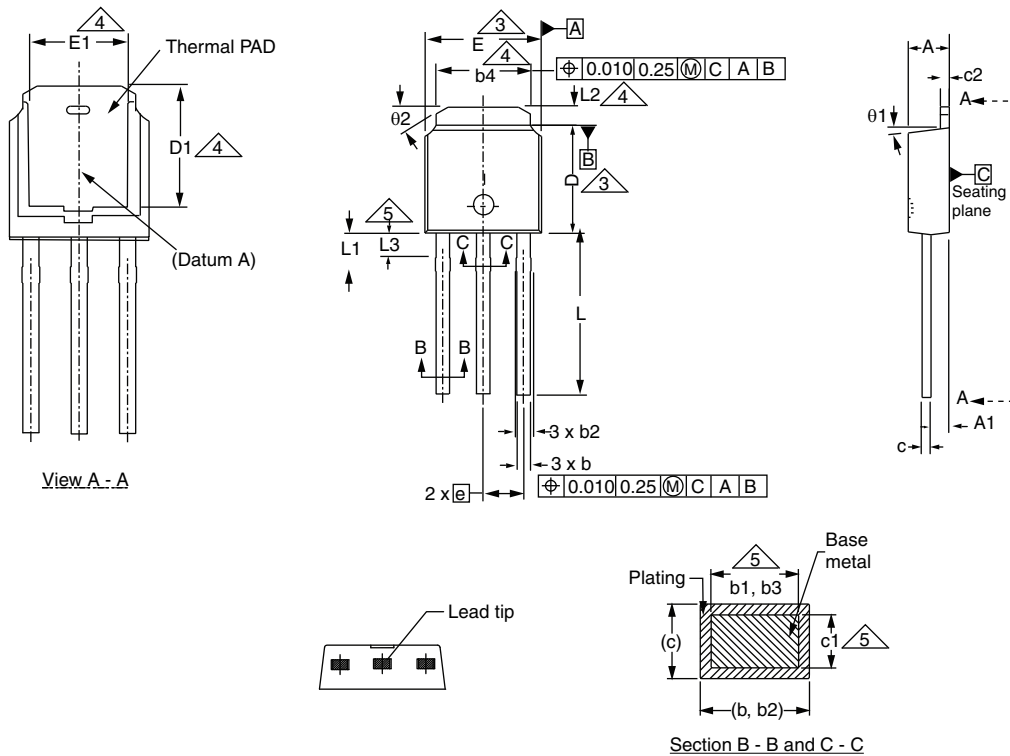
- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022  
 DWG: 5347



## Case Outline for TO-251AA (High Voltage)

## OPTION 1:



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
e	2.29 BSC		2.29 BSC	
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
01	0'	15'	0'	15'
02	25'	35'	25'	35'

ECN: E21-0682-Rev. C, 27-Dec-2021  
DWG: 5968

## Notes

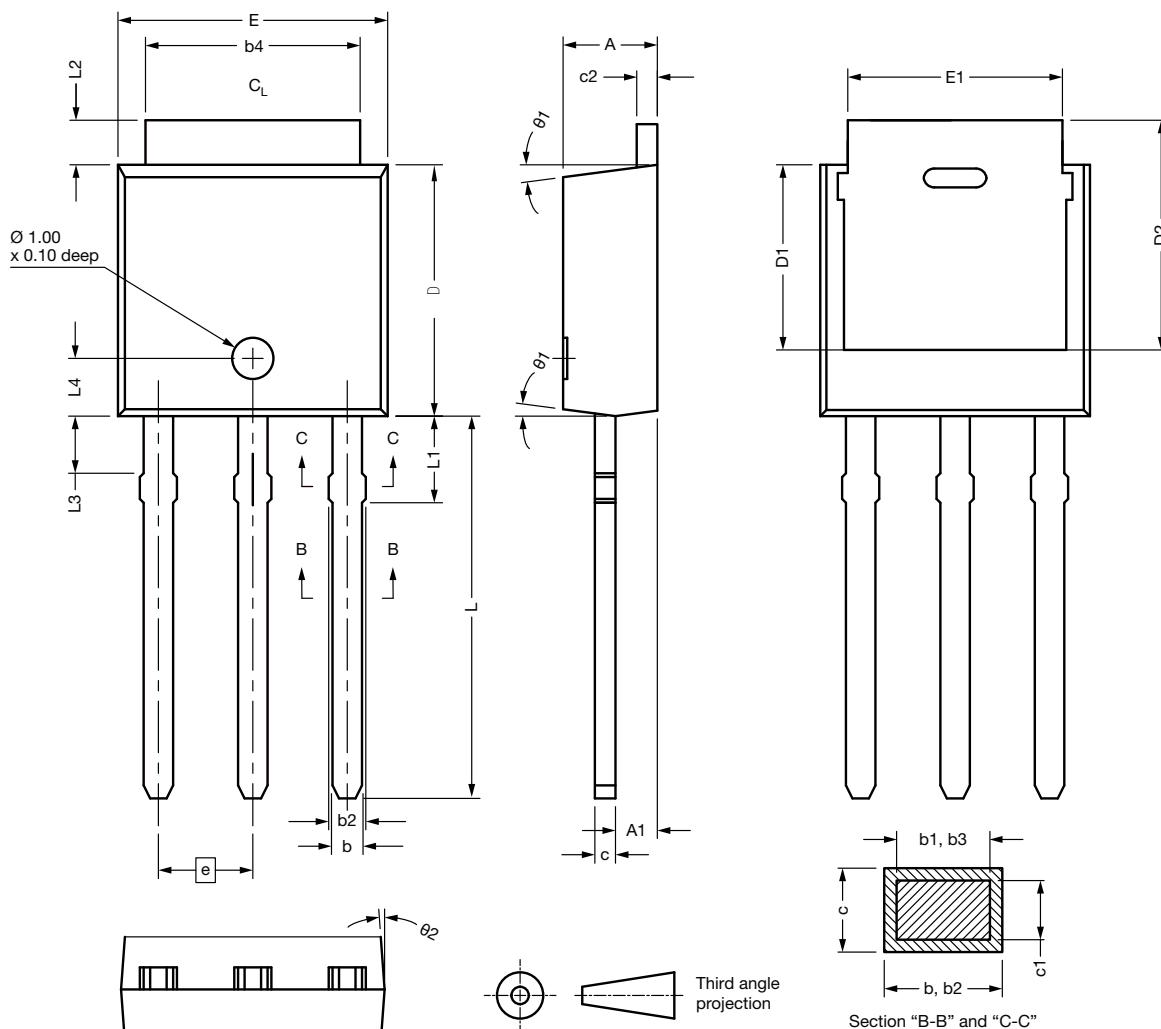
- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA


[www.vishay.com](http://www.vishay.com)

# Package Information

Vishay Siliconix

## OPTION 2: FACILITY CODE = N



DIM.	MIN.	NOM.	MAX.
A	2.180	2.285	2.390
A1	0.890	1.015	1.140
b	0.640	0.765	0.890
b1	0.640	0.715	0.790
b2	0.760	0.950	1.140
b3	0.760	0.900	1.040
b4	4.950	5.205	5.460
c	0.460	-	0.610
c1	0.410	-	0.560
c2	0.460	-	0.610
D	5.970	6.095	6.220
D1	4.300	-	-

DIM.	MIN.	NOM.	MAX.
D2	5.380	-	-
E	6.350	6.540	6.730
E1	4.32	-	-
e	2.29 BSC		
L	8.890	9.270	9.650
L1	1.910	2.100	2.290
L2	0.890	1.080	1.270
L3	1.140	1.330	1.520
L4	1.300	1.400	1.500
θ1	0°	7.5°	15°
θ2	4°	-	-

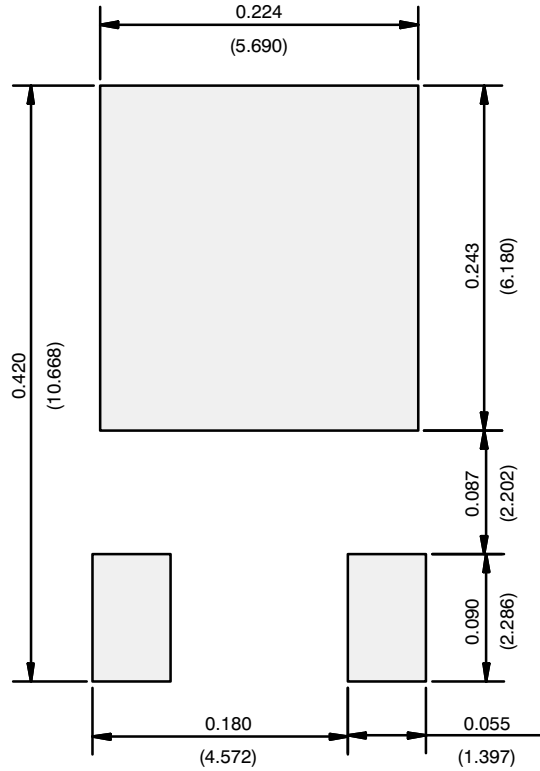
 ECN: E21-0682-Rev. C, 27-Dec-2021  
 DWG: 5968

### Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- All dimension are in millimeters, angles are in degrees
- Heat sink side flash is max. 0.8 mm



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads  
Dimensions in Inches/(mm)

[Return to Index](#)



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